DATA SHEET



MINIATURE SIGNAL RELAY

EA2/EB2 SERIES

COMPACT SIZE, FLAT-PACKAGE

DESCRIPTION

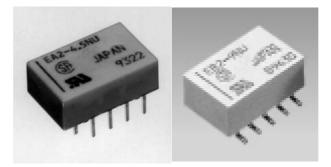
NEXEM EA2/EB2 relay is a standard miniature signal relay, compact and flat.

FEATURES

Compact and light weight FCC (1500 V) surge capacity. UL recognized and CSA certified. Low power consumption (100-200 mW)

APPLICATIONS

Electronic switching system, PBX, Terminal equipment, Telephone system



For Right Use of Miniature Relays

DO NOT EXCEED MAXIMUM RATINGS.

Do not use relays under exceeding conditions such as over ambient temperature, over voltage and over current. Incorrect use could result in abnormal heating, damage to related parts or cause burning.

READ CAUTIONS IN THE SELECTION GUIDE. Read the cautions described in EM Devices' "Miniature Relays" when you choose relays for your application.

The information in this document is subject to change without notice.

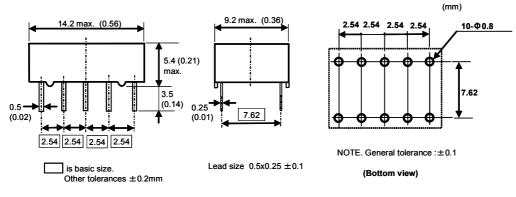
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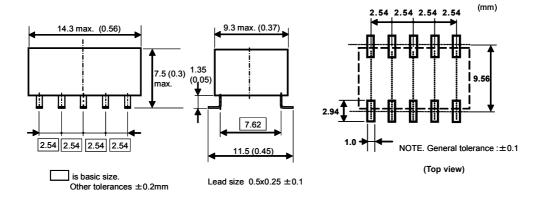
DIMENSIONS AND PAD LAYOUTS Unit: mm (inch)

EA2 SERIES



NJ type: Cover height 6.3mm, Lead length 2.8mm

EB2 SERIES

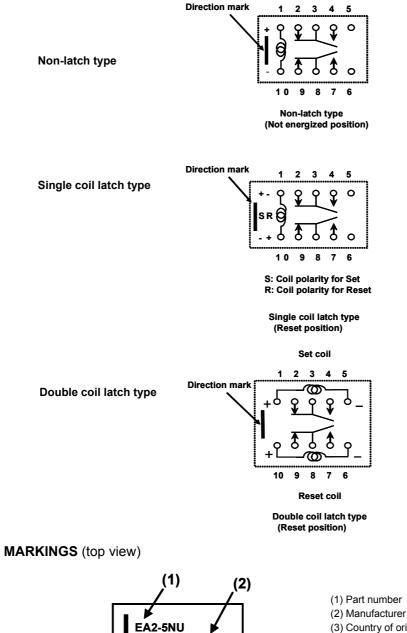


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PIN CONFIGURATIONS (Bottom view)



JAPAN

0501F

(5)

(3) Country of origin

- (4) Date code
- (5) Direction mark (pin No. 1 and 10)
- (6) UL,CSA marking

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(3)

Before using the product in this catalog, please read "Precautions" and other safety precautions listed in the printed version catalog.

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GENERAL SPECIFICATIONS

Contact Form		2 Form C		
Contact Material		Silver alloy with gold alloy overlay		
Maximum Switching Power		30 W, 62.5 VA		
Contract Dations	Maximum Switching Voltage	220 VDC, 250 VAC		
Contact Ratings	Maximum Switching Current	1 A		
	Maximum Carrying Current	2 A		
Minimum Contact R	atings	10 m VDC, 10µA *1		
Initial Contact Resis	tance	75 m Ω max. (initial)		
Operate Time (Exclu	uding bounce)	Approx. 2 ms		
Release Time (Excl	uding bounce)	Approx. 1 ms		
Insulation Resistance	e e	1000 MΩ at 500 VDC		
	Between open contacts	1000 VAC (for one minute) 1500 V surge (10x160 μs *2)		
Withstanding Voltag	Between adjacent contacts	1000 VAC (for one minute) 1500 V surge (10x160 μs *2)		
	Between coil and contacts	1000 VAC (for one minute) , 1500 V surge (10x160 µs *2)		
Shock Resistance	·	735 m/s ² (75G) (misoperation) 980 m/s ² (100G) (destructive failure)		
Vibration Resistance		10 to 55 Hz, double amplitude 3 mm(20G) (misoperation) 10 to 55 Hz, double amplitude 5 mm(30G) (destructive failure)		
Ambient Temperature		-40 to +85 °C		
Coil Temperature R	ise	18 °C at nominal coil voltage (140mW)		
Running Specifications Load		1×10^8 operations (Non-latch type) *3 1×10^7 operations (Latch type)		
		50 VDC 0.1A (resistive), 1x10 ⁶ operations at 85 °C,5Hz 10 VDC 10mA (resistive), 1x10 ⁶ operations at 85 °C,2Hz		
Weight		Approx. 1.5 g		

 * 1 This value is a reference value in the resistance load.

Minimum capacity changes depending on switching frequency and environment temperature and the load.

* **2** rise time: 10 μs , decay time to half crest: 160 μs

* 3 This shows the number of operations with fatal defects. Stable characteristics are maintained for 1 × 10⁷ operations.

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COIL SPECIFICATIONS

Non-latch Type

Non-latch Type				at 20 °C
Nominal	Coil	Must Operate	Must Release	Nominal
Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power
(VDC)	(Ω)±10%	(VDC)	(VDC)	(mW)
3	64.3	2.25	0.3	140
4.5	145	3.38	0.45	140
5	178	3.75	0.5	140
12	1028	9.0	1.2	140
24	2880	18.0	2.4	200

Single Coil Latch Type at 20						
Nominal	Coil	Set	Reset	Nominal		
Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power		
(VDC)	(Ω)±10%	(VDC)	(VDC)	(mW)		
3	90	2.25	2.25	100		
4.5	202.5	3.38	3.38	100		
5	250	3.75	3.75	100		
12	1440	9.0	9.0	100		
24	3840	18.0	18.0	150		

at 20 °C Double Coil Latch Type (Can not be driven by reverse polarity for reverse operation)

	<u> </u>				
Nominal	Coil		Set	Reset	Nominal
Coil Voltage	Resistance		Voltage**	Voltage**	Operating Power
(VDC)	(Ω)±	10%	(VDC)	(VDC)	(mW)
3	S	64.3	2.25	-	140
5	R	64.3	-	2.25	140
4.5	S	145	3.38	-	140
4.5	R	145	-	3.38	140
5	S	178	3.75	-	140
	R	178	-	3.75	
12	S	1028	9.0	-	140
	R	1028	-	9.0	
04	S	2880	18.0	-	200
24	R	2880	-	18.0	200

Note * Test by pulse voltage ** S : Set coil (pin No.1 ... (+) , pin No.5 ...(-)) R : Reset coil (pin No.10...(+) , pin No.6...(-)) The latch type relays should be initialized at appointed position before using, and should be energized to specific polarity by above polarity to avoid wrong operation. Any special coil requirement, please contact EM Devices for availability.

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SAFETY STANDARD AND RATING

1	UL Recognized	CSA Certificated						
	(UL508)*	(CSA C22.2 No14)						
	File No E73266	File No LR46266						
	30 VDC, 1 A (Resistive)							
	110 VDC, 0.3 A (Resistive)							
	125 VAC, 0.5 A (Resistive)							

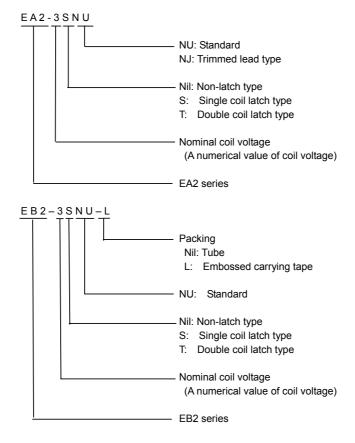
* Spacing: UL114, UL478

RECOMMENDED RELAY DRIVE CONDITIONS

Drive under conditions. If it is impossible, please inquire to EM Devices.

Non-latch type	tch type Voltage: within ±5% of nominal voltage	
Single coil latch type Double coil latch type	Square pulse (rise and fall time is rapid) Pulse height : within $\pm 5\%$ of nominal voltage Pulse width : More than 10 ms	Ambient temperature - 40 to +85 °C

PART NUMBER SYSTEM



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ORDERING PART NUMBERS

EA2 series

Option		Nominal	Coil Type			
Terminal	Packing	Coil Voltage (VDC)	Non-latch	Single Coil Latch	Double Coil Latch	
Standard		3	EA2-3NU	EA2-3SNU	EA2-3TNU	
	Tube	4.5	EA2-4.5NU	EA2-4.5SNU	EA2-4.5TNU	
		5	EA2-5NU	EA2-5SNU	EA2-5TNU	
		12	EA2-12NU	EA2-12SNU	EA2-12TNU	
		24	EA2-24NU	EA2-24SNU	EA2-24TNU	
Trimmed lead		3	EA2-3NJ	EA2-3SNJ	EA2-3TNJ	
		4.5	EA2-4.5NJ	EA2-4.5SNJ	EA2-4.5TNJ	
		5	EA2-5NJ	EA2-5SNJ	EA2-5TNJ	
		12	EA2-12NJ	EA2-12SNJ	EA2-12TNJ	
		24	EA2-24NJ	EA2-24SNJ	EA2-24TNJ	

EB2 series

Option		Nominal	Coil Type		
Terminal	packing	Coil Voltage (VDC)	Non-latch	Single Coil Latch	Double Coil Latch
	Tube	3	EB2-3NU	EB2-3SNU	EB2-3TNU
		4.5	EB2-4.5NU	EB2-4.5SNU	EB2-4.5TNU
		5	EB2-5NU	EB2-5SNU	EB2-5TNU
		12	EB2-12NU	EB2-12SNU	EB2-12TNU
Standard		24	EB2-24NU	EB2-24SNU	EB2-24TNU
Standard	Taping	3	EB2-3NU-L	EB2-3SNU-L	EB2-3TNU-L
		4.5	EB2-4.5NU-L	EB2-4.5SNU-L	EB2-4.5TNU-L
		5	EB2-5NU-L	EB2-5SNU-L	EB2-5TNU-L
		12	EB2-12NU-L	EB2-12SNU-L	EB2-12TNU-L
		24	EB2-24NU-L	EB2-24SNU-L	EB2-24TNU-L

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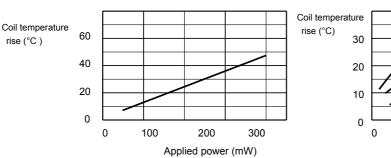
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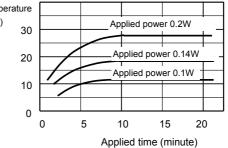
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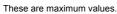
PERFORMANCE DATA

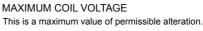




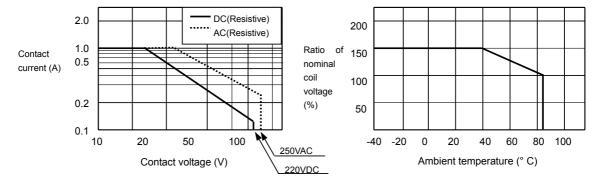


SWITCHING CAPACITY



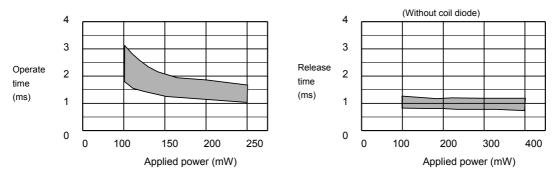


Inquire with EM Devices under continuous use.



APPLIED VOLTAGE VS. TIMING (Sample: EA2-5NU)

Inquire with EM Devices for maximum values under continuous use.



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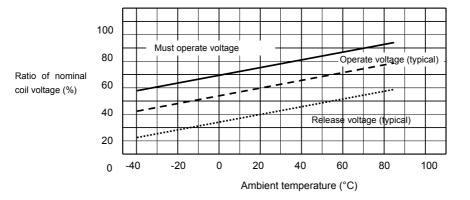
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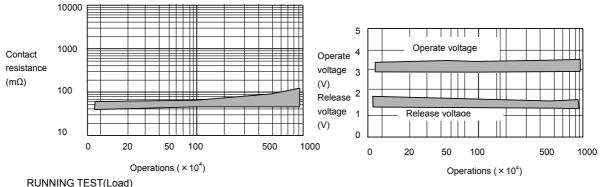


OPERATE AND RELEASE VOLTAGE VS.AMBIENT TEMPERATURE

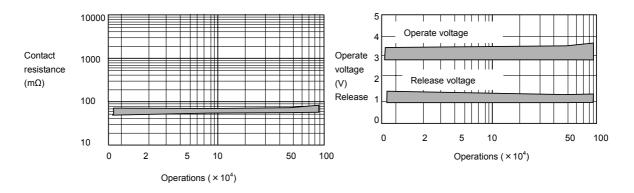
This shows a typical change of operate (release) voltage. The value of must operate is estimated, so coil voltage must be applied more than this value for safety operation. For hot start operation, please inquire with EM Devices.







(Load: 50VDC 0.1A resistive, Drive: 5VDC,5Hz,50%duty,Ambient temperature:85 °C, Sample:EA2-5NU ,10pieces)



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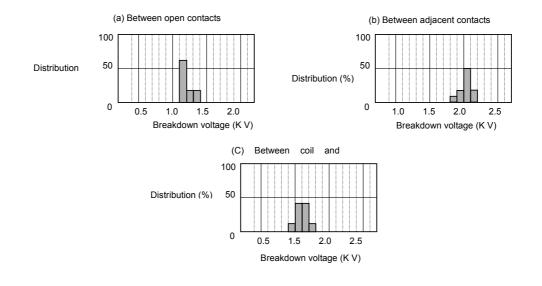
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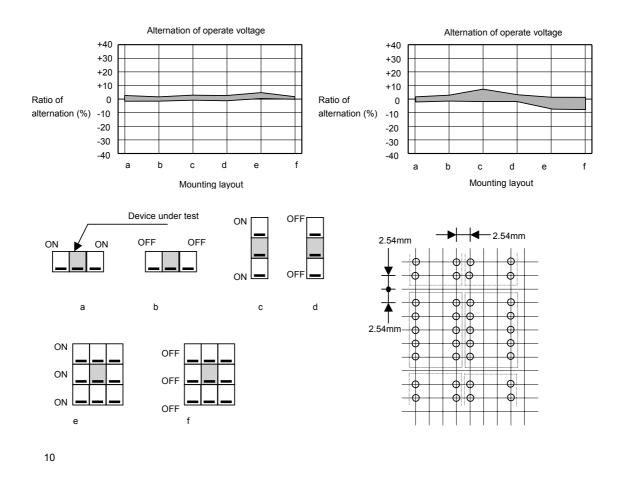


BREAKDOWN VOLTAGE

Sample: EA2-5NU 10peices



ALTERNATION OF VOLTAGE IN DENSE MOUNTING (magnet interference)

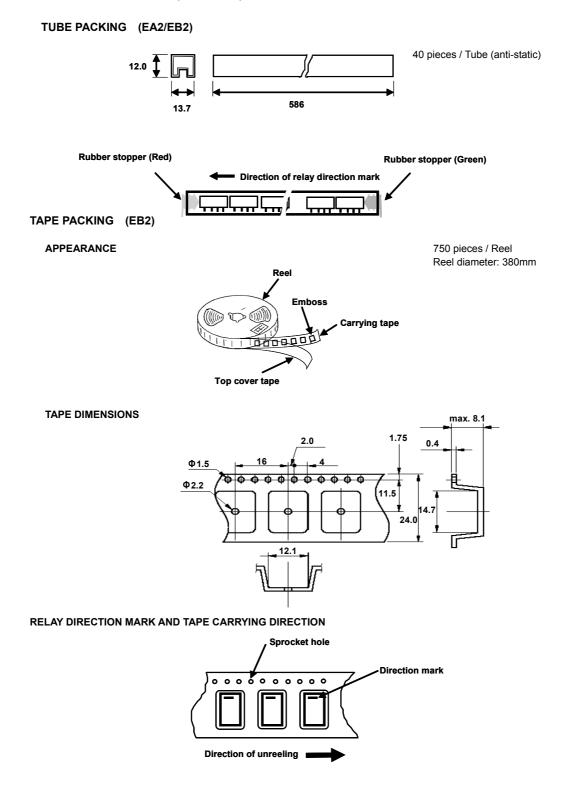


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PAKING DIMENSIONS (Unit: mm)



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SOLDERING TEMPERATURE CONDITION

THROUGH-HOLE MOUNTING (EA2)

1. Automatic soldering

Preheating: 110~ 120°C /110 sec. (max.) Solder temperature: 260°C max. Solder time: 5 seconds max.

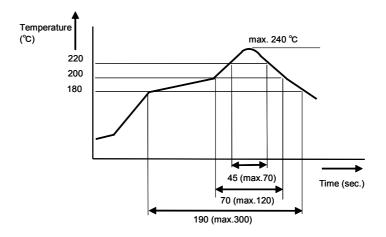
Note: EM Devices recommends cooling down a printed circuit board less than 110°C within 40 seconds after soldering.

2. Manual soldering

Solder temperature: 350°C max. Solder time: 3 seconds max.

SURFACE-MOUNTING TYPE (EB2)

IRS Method



Note:

- 1. Temperature profile shows printed circuit board surface temperature on the relay terminal portion.
- 2. Please consult EM Devices if you wish to use a temperature profile other than above.

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NOTE ON CORRECT USE

1. Notes on contact load

Make sure that the contact load is within the specified range; otherwise, the lifetime of the contacts will be shortened considerably.

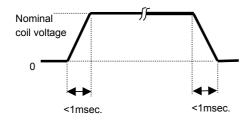
Note that the running performance shown is an example, and that it varies depending on parameters such as the type of load, switching frequency, driver circuit, and ambient temperature under the actual operating conditions. Evaluate the performance by using the actual circuit before using the relay.

2. Driving relays

- If the internal connection diagram of a relay shows + and symbols on the coil, apply the rated voltage to the relay in the specified direction. If a rippled DC current source is used, abnormalities such as beat at the coil may occur.

- The maximum voltage that can be applied to the coil of the relay varies depending on the ambient temperature. Generally, the higher the voltage applied to the coil, the shorter the operating time. Note, however, that a high voltage also increases the bounce of the contacts and the contact opening and closing frequency, which may shorten the lifetime of the contacts.

- If the driving voltage waveform of the relay coil rises and falls gradually, the inherent performance of the relay may not be fully realized. Make sure that the voltage waveform instantaneously rises and falls as a pulse.



- For a latching relay, apply a voltage to the coil according to the polarity specified in the internal connection diagram of the relay.

- If a current is applied to the coil over a long period of time, the coil temperature rises, promoting generation of organic gas inside the relay, which may result in faulty contacts. In this case, use of a latching relay is recommended.

- The operating time and release time indicate the time required for each contact to close after the voltage has been applied to or removed from the coil. However, because the relay has a mechanical structure, a bounce state exists at the end of the operating and release times. Furthermore, because additional time is required until the contact stabilizes after being in a high-resistance state, care must be taken when using the relay at high speeds.

3. Operating environment

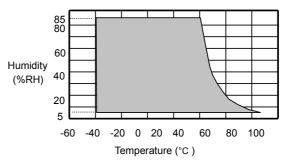
- Make sure that the relay mounted in the application set is used within the specified temperature range. Use of a relay

at a temperature outside this range may adversely affect insulation or contact performance.

- If the relay is used for a long period of time in highly humid (RH 85% or higher) environment, moisture may be absorbed into the relay. This moisture may react with the NOx and SOx generated by glow discharges that occur when the contacts are opened or closed, producing nitric or sulfuric acid. If this happens, the acid produced may corrode the metallic parts of the relay, causing operational malfunction.

- If any material containing silicon (silicon rubber, silicon oil, and silicon based coating material) is used in the neighborhood of relay, there is some possibility that these materials will emit silicon gas that will penetrate the relay. In this case, the switching contact may generate silicon compounds on the surface of contacts. This silicon compound may result in contact failure. Avoid use of relay in such an environment.

- Because the operating temperature range varies depending on the humidity, use the relay in the temperature range illustrated in the figure below. Prevent the relay from being frozen and avoid the generation of condensation.



- The relay maintains constant sealability under normal atmospheric pressure (810 to 1,200 hpa). Its sealability may be degraded or the relay may be deformed and malfunction if it is used under barometric conditions exceeding the specified range.

- The same applies when the relay is stored or transported. Keep the upper-limit value of the temperature to which the relay is exposed after it is removed from the carton box to within 50°C.

- Permanent magnets are used in polarized relays. For this reason, when magnets, transformers, or speakers are located nearby the relay characteristics may change and faulty operations may result.

- If excessive vibration or shock is applied to the relay, it may malfunction and the contacts remain closed. Vibration or shock applied to the relay during operation may cause considerable damage to or wearing of the contacts. Note that operation of a snap switch mounted close to the relay or shock due to the operation of magnetic solenoid may also cause malfunctioning.

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4. Notes on mounting relays

- When mounting a relay onto a PC board using an automatic chip mounter, if excessive force is applied to the cover of the relay when the relay is chucked or inserted, the cover may be damaged or the characteristics of the relay degraded. Keep the force applied to the relay to within 1 kg.

- Avoid bending the pins to temporarily secure the relay to the PC board. Bending the pins may degrade sealability or adversely affect the internal mechanism.

- It is recommended to solder the relay onto a PC board under the following conditions:

<1> Reflow soldering

Refer to the recommended soldering temperature profile. <2> Flow soldering

Solder temperature: 260°C max., Time: 5 seconds max.

Preheating: 110~ 120°C /110 sec. (max.)

<3> Manual soldering

Solder temperature: 350°C, Time: 2~3 seconds

- Ventilation immediately after soldering is recommended. Avoid immersing the relay in cleaning solvent immediately after soldering due to the danger of thermal shock being applied to the relay.

- Use an alcohol-based or water-based cleaning solvent. Never use thinner and benzene because they may damage the relay housing.

- Do not use ultrasonic cleaning because the vibration energy generated by the ultrasonic waves may cause the contacts to remain closed.

5. Handling

- Relays are packaged in magazine cases for shipment. If a space is created in the case after some relays have been removed, be sure to insert a stopper to secure the remaining relays in the case. If relays are not well secured, vibration during transportation may cause malfunctioning of the contacts.

- Exercise care in handling the relay so as to avoid dropping it or allowing it to fall. Do not use a relay that has been dropped. If a relay drops from a workbench to the floor, a shock of 9,800 m/s2 (1,000 G) or more is applied to the relay, possibly damaging its functions. Even if a light shock has been applied to the relay, thoroughly evaluate its operation before using it.

- Latching relays are factory-set to the reset state for shipment. A latching relay may be set, however, by vibration or shock applied while being transported. Be sure to forcibly reset the relay before using it in the application set. Also note that the relay may be set by unexpected vibration or shock when it is used in a portable set.

- The sealability of a surface-mount (SMT) relay may be lost if the relay absorbs moisture and is then heated during soldering. When storing relays, therefore, observe the following points:

<1> For standard packing, please use relays within 12 months after delivery. (Storage conditions: 30 °C / 60% RH) If the relays have moisture absorption, dehumidify as follows.

Tape packing: 50±5 °C, 200~300 hours.

Simple relay: 85±5 °C, 48 hours.

<2> For MBB packing, please use relays within 2 years after

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delivery.

(Storage conditions: 30 °C / 60% RH) After open MBB packing, please use within 3 months. (Storage conditions: 30 °C / 60% RH)



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While EM Devices Corporation has been making continuous effort to enhance the reliability of its electronic components, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an EM Devices electronic component, customers must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features. EM Devices' products are classified into the following three quality grades:

"Standard," "Special, "and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

- Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
- Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
- Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of EM Devices' products are "Standard" unless otherwise specified in EM Devices' Data Sheets or Data Books. If customers intend to use EM Devices' products for applications other than those specified for Standard quality grade, they should contact an EM Devices sales representative in advance.

(Note)

- (1) "EM Devices" as used in this statement means EM Devices Corporation and also includes its majorityowned subsidiaries.
- (2) "EM Devices electronic component products" means any electronic component product developed or manufactured by or for EM Devices (as defined above).

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